



SSC8PN0GN2

High Frequency High Gain PNP with NPN Power BJT

● Features

	V_{CE}	V_{BE}	$V_{CE(SAT)}$ typ	I_C
PNP BJT	-40V	-6V	-150mV	-1A
NPN BJT	40V	6V	120mV	0.2A

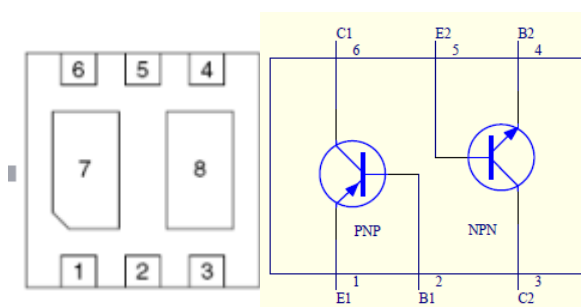
● Applications

- battery powered circuits
- low in-line power dissipation circuits

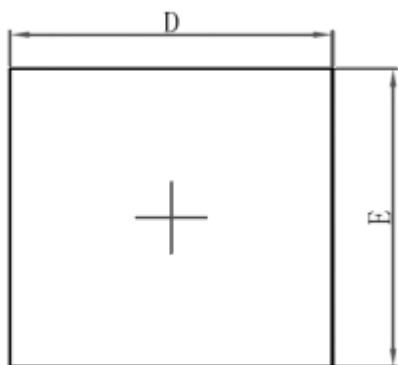
● General Description

SSC8PN0GN2 combines an Power NPN Transistor and a Power PNP Transistor . The tiny and thin outline saves PCB consumption.

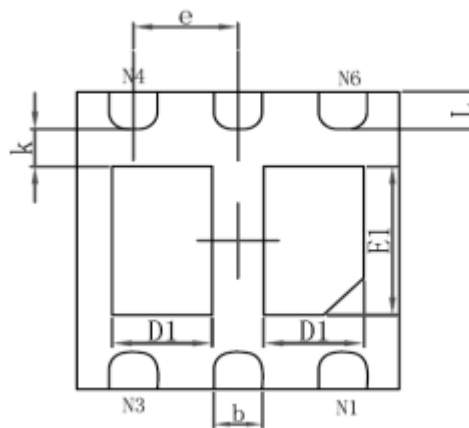
● Pin configuration



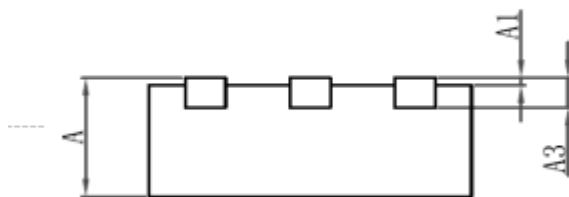
● Package Information



Top View



Bottom View



Side View

DFN2X2X0.75

Symbol	Dimensions In Millimeters	
	Min.	Max.
A	0.700/0.800	0.800/0.900
A1	0.000	0.050
A3	0.203REF.	
D	1.924	2.076
E	1.924	2.076
D1	0.520	0.720
E1	0.900	1.100
k	0.200MIN.	
b	0.250	0.350
e	0.650TYP.	
L	0.174	0.326



SSC8PN0GN2

- **Absolute Maximum Ratings @ TA = 25°C unless otherwise specified**

Parameter	Symbol	P-channel	Unit
NPN Transistor			
Collector-Base Voltage	V _{CBO}	60	V
Collector-Emitter Voltage	V _{CEO}	40	V
Emitter-Base Voltage	V _{EBO}	6	V
Collector Current ^(Note 1)	I _C	0.2	A
Pulse collector current ^(Note3)	I _{CM}	0.4	A
PNP Transistor			
Collector-Base Voltage	V _{CBO}	-40	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V _{EBO}	-6	V
Collector Current ^(Note 1)	I _C	-1	A
Pulse collector current ^(Note3)	I _{CM}	-2	A
Power Dissipation and temperature			
Power Dissipation ^(Note 1)	P _C	1	W
Storage and Junction Temperature Range	T _J ,	-55~+150	°C

- **Thermal resistance ratings**

Parameter	Symbol	Value	Unit
Junction-to-Ambient Thermal Resistance ^(Note 1)	R _{θJA}	115	°C/W
Junction-to-Ambient Thermal Resistance ^(Note 2)	R _{θJA}	220	°C/W

- **Order information**

Device	Package	Marking
SSC8PN0GN2	DFN2X2-6	PN0A ●



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● Electrical Characteristics @ TA = 25°C unless otherwise specified

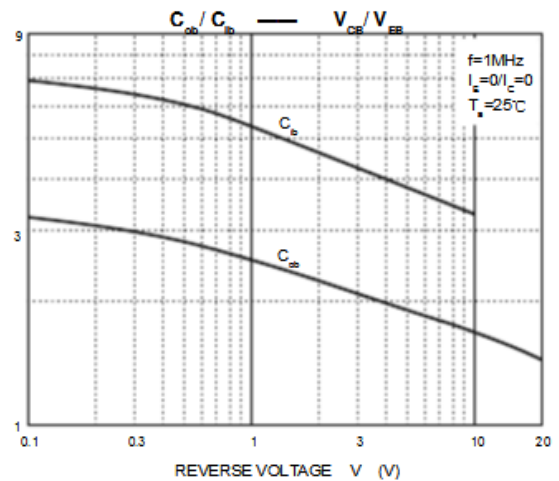
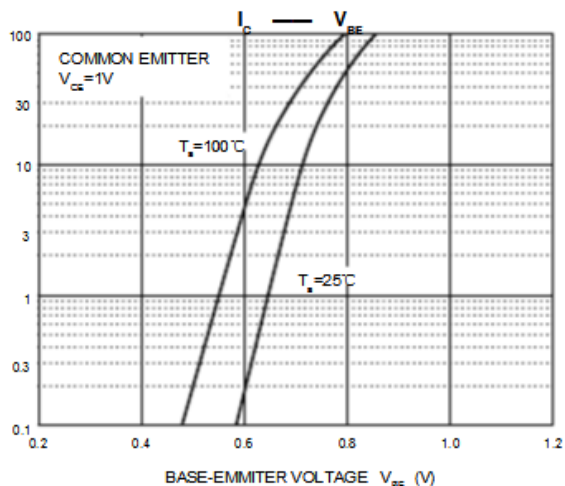
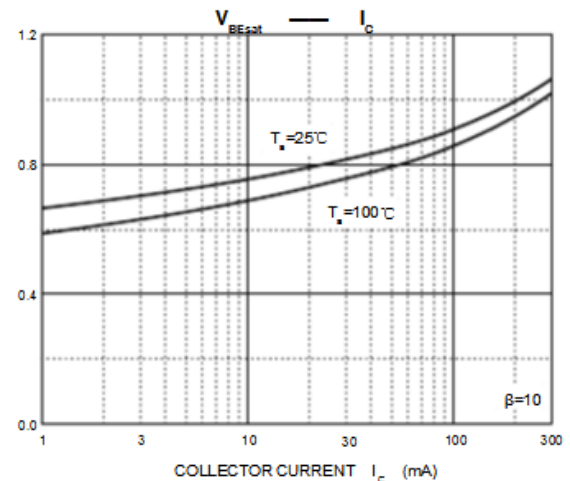
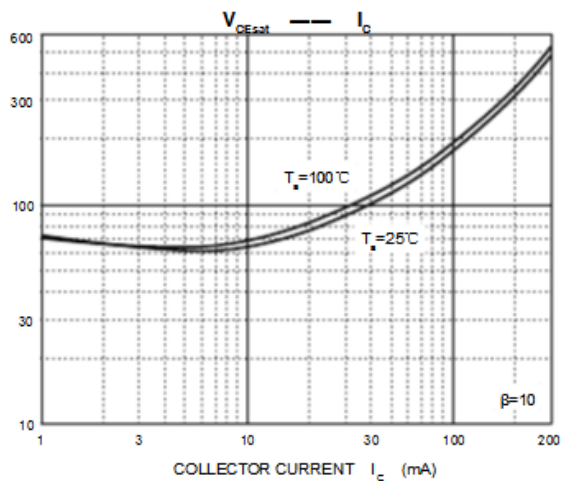
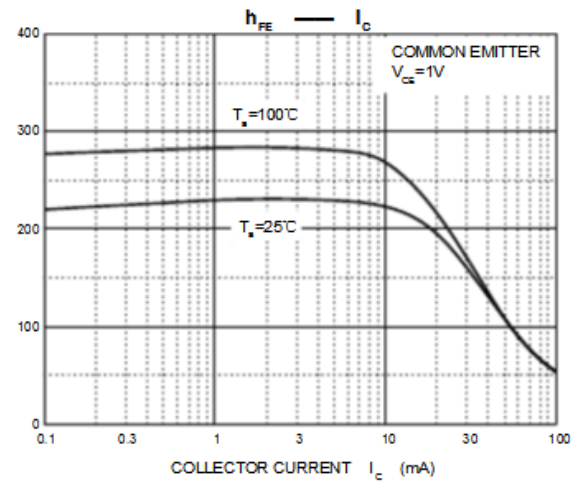
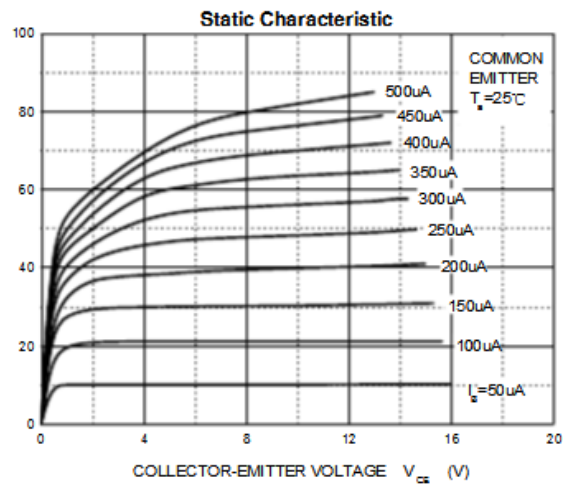
Parameter ^(Note 3)	Symbol	Test Conditions	Min	Typ	Max	Unit
NPN Transistor						
Collector-Base Breakdown Voltage	BV _{CBO}	I _C =10uA, I _E =0mA	60			V
Collector-Emitter Breakdown Voltage	BV _{CEO}	I _C =1mA, I _B =0mA	40			V
Emitter-Base Breakdown Voltage	BV _{EBO}	I _E =10uA, I _C =0mA	6			V
Collector cut off current	I _{CBO}	V _{CB} =30V,I _E =0mA			90	nA
Emitter cut off current	I _{EBO}	V _{EB} =3,I _C =0mA			90	nA
DC Current Gain	HFE	V _{CE} =1V,I _C =-10mA	100		300	
DC Current Gain	HFE	V _{CE} =1V,I _C =100mA	30		300	
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	I _C =50mA,I _B =5mA		0.12	0.3	V
Base-emitter saturation voltage	V _{BE(SAT)}	I _C =-50mA ,I _B =5mA			0.95	V
Transition frequency	f _T	V _{CE} =-20V, I _c =10mA, f=100MHz	250			MHz
Delay time	td	V _{CC} =3V,V _{BE} =0.5V I _c =10mA,I _b 1=1.0mA			35	ns
Rise time	tr				35	ns
Storage time	ts	V _{CC} =3V,I _c =10mA, I _b 1=-I _b 2=1.0mA			200	ns
Fall time	tf				50	ns
PNP Transistor						
Collector-Base Breakdown Voltage	BV _{CBO}	I _C =-50uA, I _E =0mA	-60			V
Collector-Emitter Breakdown Voltage	BV _{CEO}	I _C =-1mA, I _B =0mA	-40			V
Emitter-Base Breakdown Voltage	BV _{EBO}	I _E =-50uA, I _C =0mA	-6			V
Collector cut off current	I _{CBO}	V _{CB} =-35V,I _E =0mA			60	nA
Emitter cut off current	I _{EBO}	V _{EB} =-4,I _C =0mA			60	nA
DC Current Gain	HFE	V _{CE} =-1V,I _C =-100mA	80		300	
DC Current Gain	HFE	V _{CE} =-2V,I _C =500mA	100		400	
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	I _C =-800mA,I _B =-80mA		0.15	0.25	V
Base-emitter saturation voltage	V _{BE(SAT)}	I _C =-800mA,I _B =-80mA			1.1	V
Transition frequency	f _T	V _{CE} =-6V, I _c =20mA, f=30MHz	150			MHz
Delay time	td	V _{CC} =-3V,V _{BE} =0.5V I _c =10mA,I _b 1=1.0mA			35	ns
Rise time	tr				35	ns
Storage time	ts	V _{CC} =-3V,I _c =10mA, I _b 1=-I _b 2=1.0mA			200	ns
Fall time	tf				50	ns

Note1. Surface mounted on FR-4 Board using 1 square inch pad size, 1oz copper.

Note2. Surface mounted on FR-4 board using minimum pad size, 1oz copper

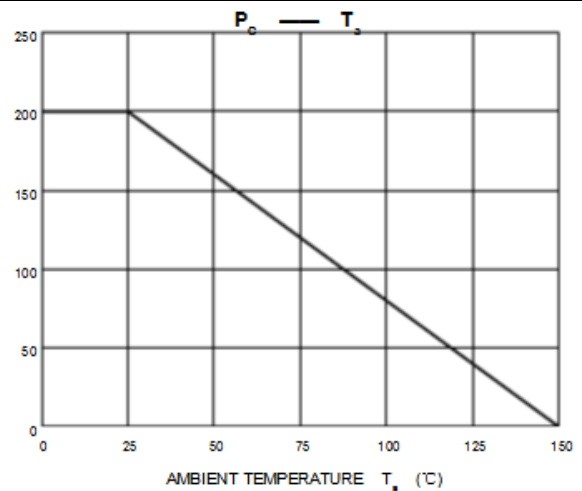
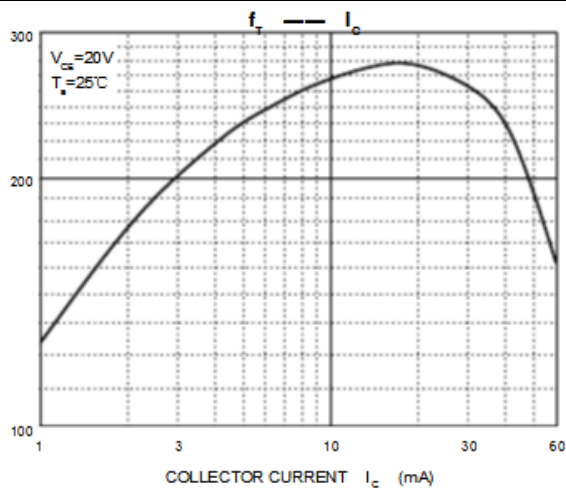
Note3. Pulse width=300μs, Duty Cycle

PNP and NPN Typical Performance Characteristics





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